

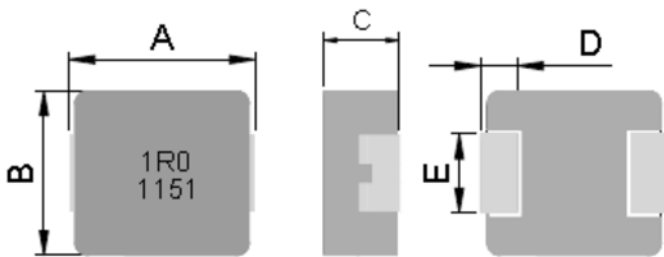
FEATRLRES

- Carbonyl Powder.
- Compact design.
- High current · low DCR · high efficiency.
- Very low acoustic noise and very low leakage flux noise.
- High reliability.
- 100% Lead(Pb)-Free and RoHS compliant.

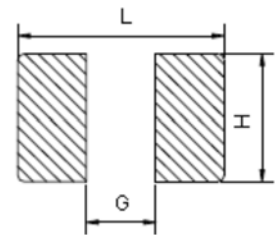
APPLICATIONS

- Note PC power system , incl. IMVP-6
- DC/DC converter .

CONFIGLRATIONS & DIMENSIONS (unit in mm)



Recommended Land pattern



Type	A	B	C	D	E	L	G	H
HMPL0515HP	5.7±0.3	5.2±0.2	1.3±0.2	1.1±0.3	2.5±0.3	6.2	2.2	2.8

Note:

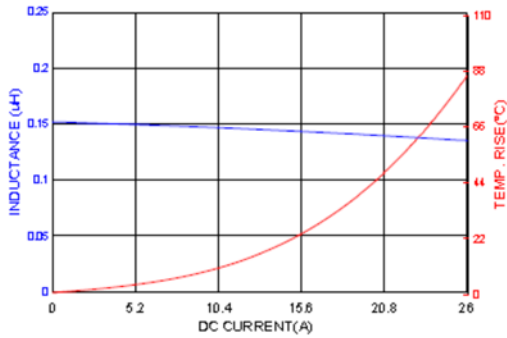
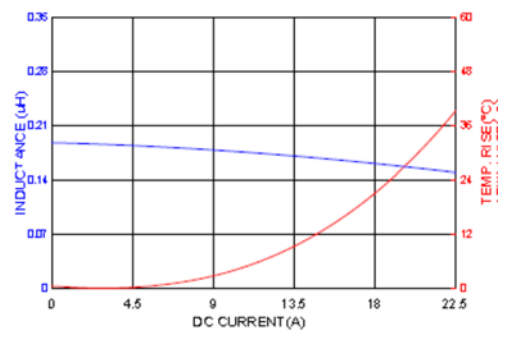
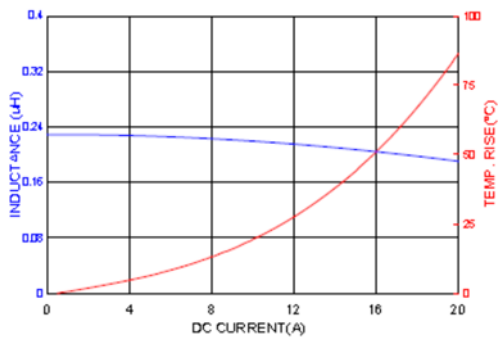
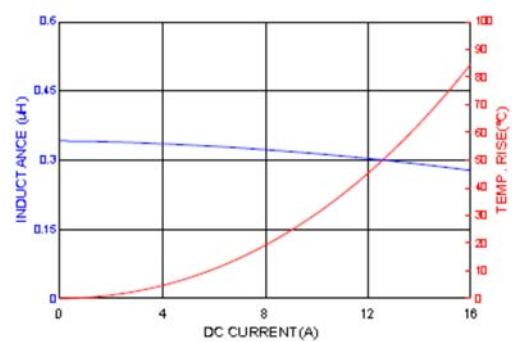
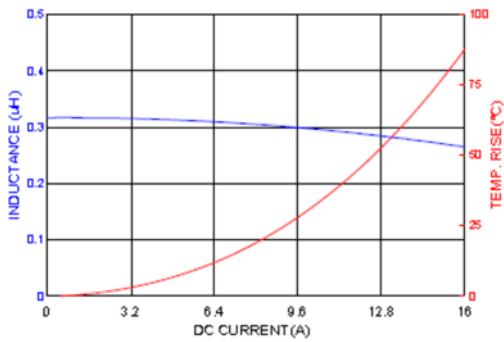
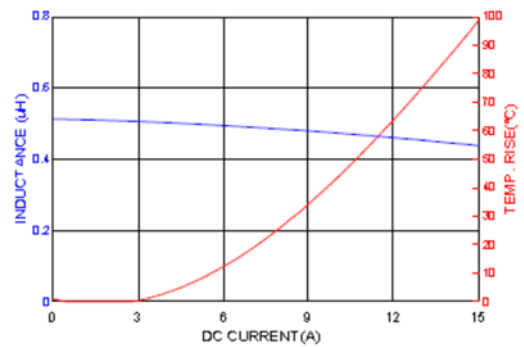
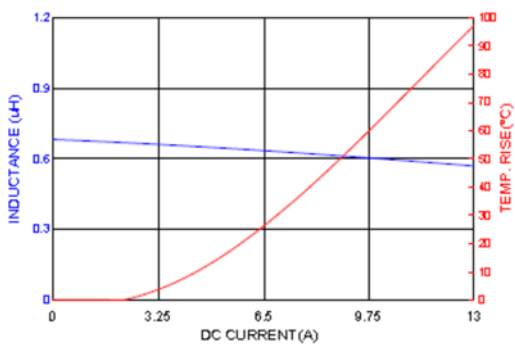
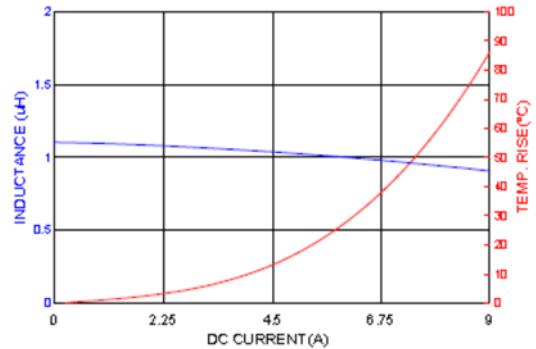
1. The above PCB layout reference only.
2. Recommend solder paste thickness at 0.12mm and above.

ELECTRICAL CHARACTERISTICS

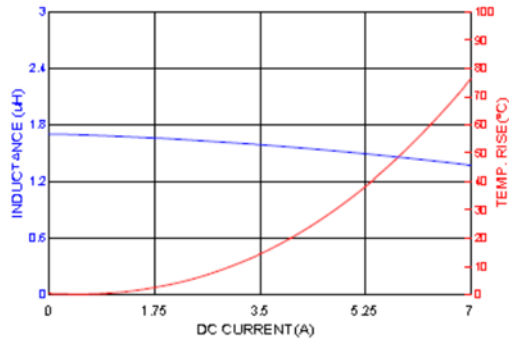
Part Number	Inductance L0	I rms (A) Typ.	I sat (A) Typ.	DCR(mΩ)	DCR(mΩ)
	(uH)±20% @ 0 A			Typ.@25°C	Max.@25°C
HMPL0515HP-R15YG-D	0.15±30%	16	25	3.6	4.1
HMPL0515HP-R20YG-D	0.20±30%	15	22.5	3.8	4.2
HMPL0515HP-R22YG-D	0.22±30%	12	20	5.0	6.5
HMPL0515HP-R33MG-D	0.33	9.0	16	8.5	9.8
HMPL0515HP-R36MG-D	0.36	8.5	15.5	10	12.5
HMPL0515HP-R47MG-D	0.47	8.0	15	12.0	13.8
HMPL0515HP-R68MG-D	0.68	7.0	13	14	16.2
HMPL0515HP-1R0MG-D	1.00	6.0	9.0	22	25.3
HMPL0515HP-1R5MG-D	1.50	4.5	7.0	39	45
HMPL0515HP-2R2MG-D	2.20	4.0	6.0	45	52
HMPL0515HP-3R3MG-D	3.30	3.2	4.5	78	90
HMPL0515HP-4R7MG-D	4.70	2.7	4.0	103	118
HMPL0515HP-5R6MG-D	5.60	2.4	3.2	126	152
HMPL0515HP-6R8MG-D	6.80	2.3	3.0	142	171
HMPL0515HP-8R2MG-D	8.20	2.1	2.6	175	210
HMPL0515HP-100MG-D	10.0	2.0	2.3	210	235
HMPL0515HP-220MG-D	22.0	1.2	1.7	405	466

Note:

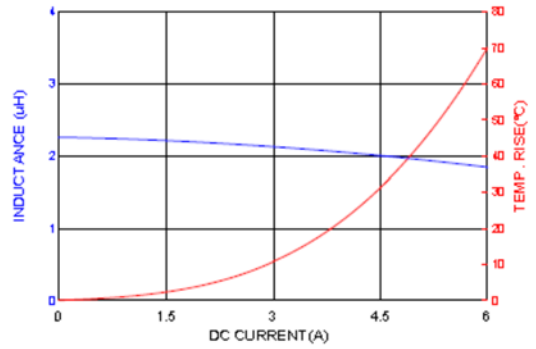
1. Test frequency : Ls : 100KHz /1.0V.
2. All test data referenced to 25°C ambient.
3. Testing Instrument(or equ) : L: HP4284A,CH11025,CH3302,CH1320,CH1320S LCR METER / Rdc:CH16502,Agilent33420A MICRO OHMMETER.
4. Heat Rated Current (I_{rms}) will cause the coil temperature rise approximately ΔT of 40°C
5. Saturation Current (I_{sat}) will cause L0 to drop approximately 20%.
6. The part temperature (ambient + temp rise) should not exceed 125°C under worst case operating conditions. Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
7. Special inquiries besides the above common used types can be met on your requirement.

TYPICALELECTRICALCHARACTERISTICS:
HMPL0512HP-R15

HMPL0512HP-R20

HMPL0512HP-R22

HMPL0512HP-R33

HMPL0512HP-R36

HMPL0512HP-R47

HMPL0512HP-R68

HMPL0512HP-1R0


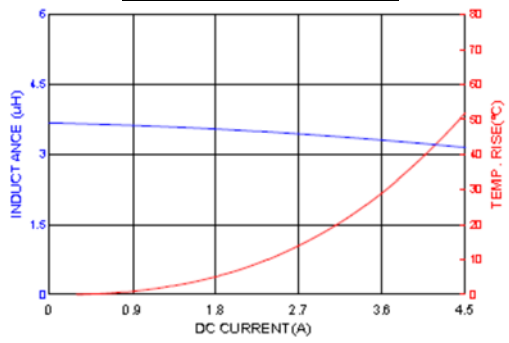
HMPL0512HP-1R2



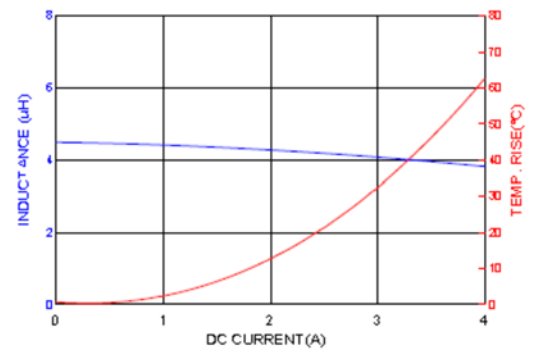
HMPL0512HP-1R5



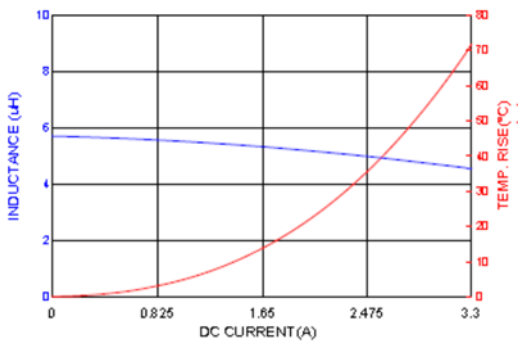
HMPL0512HP-2R2



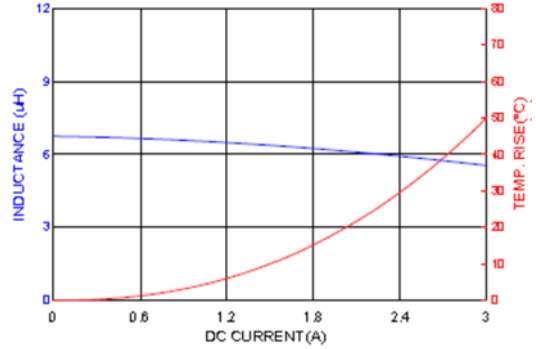
HMPL0512HP-3R3



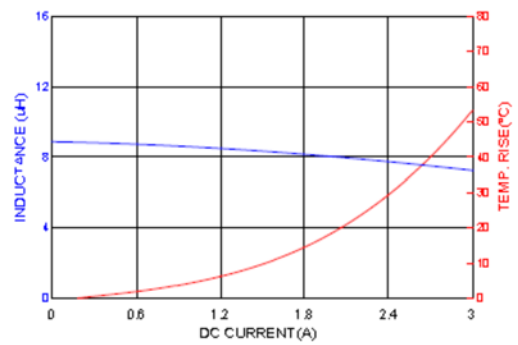
HMPL0512HP-4R7



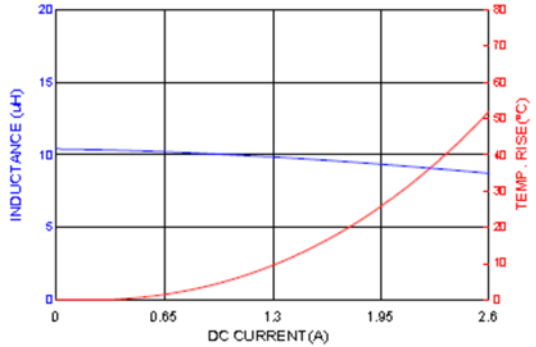
HMPL0512HP-5R6

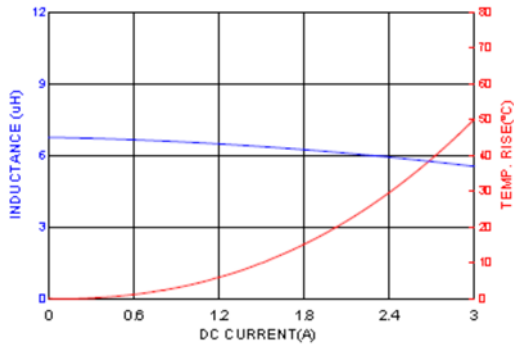
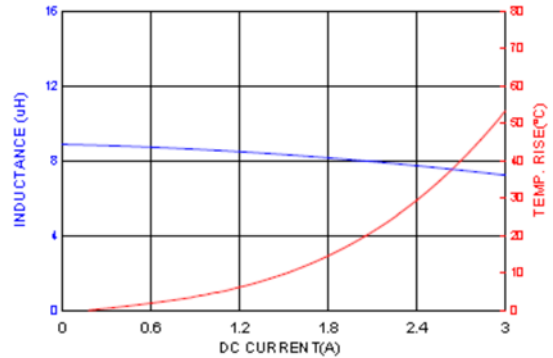


HMPL0512HP-6R8



HMPL0512HP-8R2



HMPL0512HP-100

HMPL0512HP-220


Reliability and Test Condition

Item	Performance	Test Condition
Operating temperature	-40~+125°C (Including self - temperature rise)	
Storage temperature	1. -10~+40°C, 50~60%RH (Product with taping) 2. -40~+125°C (on board)	
Electrical Performance Test		
Inductance	Refer to standard electrical characteristics list.	HP4284A, CH11025, CH3302, CH1320, CH1320S LCR Meter.
DCR		CH16502, Agilent33420A Micro-Ohm Meter.
Saturation Current (Isat)	Approximately ΔL 30%	Saturation DC Current (Isat) will cause L0 to drop ΔL (%)
Heat Rated Current (Irms)	Approximately ΔT 40°C	Heat Rated Current (Irms) will cause the coil temperature rise ΔT (°C). 1. Applied the allowed DC current 2. Temperature measured by digital surface thermometer
Reliability Test		
Life Test	Appearance : No damage. Inductance : within $\pm 10\%$ of initial value Q : Shall not exceed the specification value. RDC : within $\pm 15\%$ of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020D Classification Reflow Profiles) Temperature : 125 ± 2 °C (Inductor) Applied current : rated current Duration : 1000 ± 12 hrs Measured at room temperature after placing for 24 ± 2 hrs
Load Humidity		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020D Classification Reflow Profiles) Humidity : 85 ± 2 % R.H, Temperature : 85° ± 2 °C Duration : 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24 ± 2 hrs
Moisture Resistance		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020D Classification Reflow Profiles) 1. Baked at 50° ± 2 °C for 25hrs, measured at room temperature after placing for 4 hrs. 2. Raise temperature to 65 ± 2 °C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25° ± 2 °C in 2.5hrs. 3. Raise temperature to 65 ± 2 °C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25° ± 2 °C in 2.5hrs, keep at 25° ± 2 °C for 2 hrs then keep at -10° ± 2 °C for 3 hrs 4. Keep at 25° ± 2 °C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.

Thermal shock		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Condition for 1 cycle Step1 : -40±2°C 30±5min Step2 : 25±2°C ≤0.5min Step3 : 125±2°C 30±5min Number of cycles : 500 Measured at room temperature after placing for 24±2 hrs															
Vibration		Oscillation Frequency: 10 ~ 2K ~ 10Hz for 20 minutes Equipment : Vibration checker Total Amplitude:1.52mm±10% Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations).															
Bending		Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec.															
Shock	Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	<table border="1"> <thead> <tr> <th>Type</th> <th>Peak value (g's)</th> <th>Normal duration (D) (ms)</th> <th>Wave form</th> <th>Velocity change (V)ft/sec</th> </tr> </thead> <tbody> <tr> <td>SMD</td> <td>50</td> <td>11</td> <td>Half-sine</td> <td>11.3</td> </tr> <tr> <td>Lead</td> <td>50</td> <td>11</td> <td>Half-sine</td> <td>11.3</td> </tr> </tbody> </table>	Type	Peak value (g's)	Normal duration (D) (ms)	Wave form	Velocity change (V)ft/sec	SMD	50	11	Half-sine	11.3	Lead	50	11	Half-sine	11.3
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SMD	50	11	Half-sine	11.3													
Lead	50	11	Half-sine	11.3													
Solder ability	More than 95% of the terminal electrode should be covered with solder.	Preheat: 150°C,60sec. Solder: Sn96.5% Ag3% Cu0.5% Temperature: 245±5°C Flux for lead free: Rosin. 9.5% Dip time: 4±1sec Depth: completely cover the termination															
Resistance to Soldering Heat		Depth: completely cover the termination <table border="1"> <thead> <tr> <th>Temperature(°C)</th> <th>Time(s)</th> <th>Temperature ramp/immersion and emersion rate</th> <th>Number of heat cycles</th> </tr> </thead> <tbody> <tr> <td>260 ±5 (solder temp)</td> <td>10 ±1</td> <td>25mm/s ±6 mm/s</td> <td>1</td> </tr> </tbody> </table>	Temperature(°C)	Time(s)	Temperature ramp/immersion and emersion rate	Number of heat cycles	260 ±5 (solder temp)	10 ±1	25mm/s ±6 mm/s	1							
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260 ±5 (solder temp)	10 ±1	25mm/s ±6 mm/s	1														
Terminal Strength	Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value e	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles With the component mounted on a PCB with the device to be tested, apply a force(>0805:1kg , <=0805:0.5kg)to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested. 															

Note : When there are questions concerning measurement result : measurement shall be made after 48 ± 2 hours of recovery under the standard condition.